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To the Honorable Commission	ched original documents of copy thereof.
1. Name of conveying party(ies): Jang-Won Park Soo-Yeul Oh Il-Jin Youn Byung-Chan Ahn Jae-Ho Lee Additional name(s) of conveying party(ies) attached? Yes ✓ No 3. Nature of conveyance: ✓ Assignment	2. Name and address of receiving party(ies) Name: Samsung Electronics Co., Ltd. Internal Address: 416, Maetan-dong, Yeongtong-gu Suwon-si, Gyeonggi-do Republic of Korea 442-370 Street Address: Same as above
	City:State:Zip:
	Ony
Execution Date: January 31, 2008	Additional name(s) & address(es) attached? ☐ Yes ✓ No
4. Application number(s) or patent number(s): If this document is being filed together with a new application No.(s)	cation, the execution date of the application is: 01/31/08 B. Patent No.(s)
Additional numbers attached? Yes Vo	
Name and address of party to whom correspondence concerning document should be mailed: Name:Docket Clerk Internal Address:P.O. Drawer 800889	6. Total number of applications and patents involved: 7. Total fee (37 CFR 3.41)\$ ✓ Enclosed
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9. Signature. William A. Munck, Registration No. 39,308 Name of Person Signing Name of Person Signing Name of Person Signing Name of Person Signing	
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REEL: 020535 FRAME: 0019

PATENT

ASSIGNMENT

WHEREAS, We, Jang-Won Park, resident of Yongin-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, Il-Jin Youn, resident of Bucheon-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, Byung-Chan Ahn, resident of Dongjak-gu, Seoul, Republic of Korea, citizen of Republic of Korea, Jae-Ho Lee, resident of Suwon-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, and Soo-Yeul Oh, resident of Songpa-gu, Seoul, Republic of Korea, citizen of Republic of Korea, have invented certain new and useful improvements in an "APPARATUS AND METHOD FOR UPLINK SCHEDULING IN A BROADBAND WIRELESS COMMUNICATION SYSTEM," disclosed in an application for United States Letters Patent (Application Serial No. _/_____, filed on _______), said application having been executed concurrently herewith;

WHEREAS, SAMSUNG ELECTRONICS CO., LTD, a corporation organized under the laws of the Republic of Korea, having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, 442-370, Republic of Korea (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring my entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck or John T. Mockler of Munck Butrus Carter, P.C. to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

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We hereby further agree that we will communicate to said ASSIGNEE, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date: January 31, 2008

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